Not for New Designs

EGF1A, EGF1B, EGF1C, EGF1D

Vishay General Semiconductor

# Surface-Mount Glass Passivated Ultrafast Rectifier

- Superectifier structure for high reliability condition
  Cavity-free glass-passivated junction
- Ideal for automated placement
- Ultrafast reverse recovery time
- · Low switching losses, high efficiency
- · High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 250  $^\circ\mathrm{C}$
- AEC-Q101 qualified

**FEATURES** 

- Automotive ordering code: base P/NHE3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **TYPICAL APPLICATIONS**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

## **MECHANICAL DATA**

**Case:** GF1 (DO-214BA), molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/NHE3\_X - RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B, ...)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

HE3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| <b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)                |                      |             |       |       |       |      |  |
|---|----------------------|-------------|-------|-------|-------|------|--|
| PARAMETER   | SYMBOL               | EGF1A       | EGF1B | EGF1C | EGF1D | UNIT |  |
| Device marking code   |                      | EA          | EB    | EC    | ED    |      |  |
| Maximum repetitive peak reverse voltage   | V <sub>RRM</sub>     | 50          | 100   | 150   | 200   | V    |  |
| Maximum RMS voltage   | V <sub>RMS</sub>     | 35          | 70    | 105   | 140   | V    |  |
| Maximum DC blocking voltage   | V <sub>DC</sub>      | 50          | 100   | 150   | 200   | V    |  |
| Maximum average forward rectified current at $T_L$ = 125 °C                           | I <sub>F(AV)</sub>   |             | А     |       |       |      |  |
| Peak forward surge current 8.3 ms single half sine-wave<br>superimposed on rated load | I <sub>FSM</sub>     |             | А     |       |       |      |  |
| Operating junction and storage temperature range                                      | TJ, T <sub>STG</sub> | -65 to +175 |       |       |       | °C   |  |





Superectifier<sup>®</sup>

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Cathode O Anode

# LINKS TO ADDITIONAL RESOURCES

3D Models

| PRIMARY CHARACTERISTICS |                           |  |  |  |  |  |
|-------------------------|---------------------------|--|--|--|--|--|
| I <sub>F(AV)</sub>      | 1.0 A                     |  |  |  |  |  |
| V <sub>RRM</sub>        | 50 V, 100 V, 150 V, 200 V |  |  |  |  |  |
| I <sub>FSM</sub>        | 30 A                      |  |  |  |  |  |
| t <sub>rr</sub>         | 50 ns                     |  |  |  |  |  |
| V <sub>F</sub>          | 1.0 V                     |  |  |  |  |  |
| T <sub>J</sub> max.     | 175 °C                    |  |  |  |  |  |
| Package                 | GF1 (DO-214BA)            |  |  |  |  |  |
| Circuit configuration   | Single                    |  |  |  |  |  |





COMPLIANT

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| <b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted) |   |                         |                               |       |       |       |       |      |
|---|---|-------------------------|-------------------------------|-------|-------|-------|-------|------|
| PARAMETER   | TEST CONDITIONS   |                         | SYMBOL                        | EGF1A | EGF1B | EGF1C | EGF1D | UNIT |
| Maximum instantaneous forward voltage   | 1.0 A   |                         | V <sub>F</sub> <sup>(1)</sup> | 1.0   |       |       |       | V    |
| Maximum DC reverse current<br>at rated DC blocking voltage                        |   | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(1)</sup> | 5.0   |       |       | μA    |      |
|   |   | T <sub>A</sub> = 125 °C | 'R ` ′                        | 50    |       |       |       |      |
| Typical reverse recovery time   | $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$ |                         | t <sub>rr</sub>               | 50    |       |       | ns    |      |
| Typical junction capacitance  | 4.0 V, 1 MHz  |                         | CJ                            | 15    |       |       | pF    |      |

Note

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

| <b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted) |                                 |       |       |       |       |      |  |  |
|--|---------------------------------|-------|-------|-------|-------|------|--|--|
| PARAMETER  | SYMBOL                          | EGF1A | EGF1B | EGF1C | EGF1D | UNIT |  |  |
| Typical thermal resistance   | R <sub>0JA</sub> <sup>(1)</sup> | 85    |       |       |       | °C/W |  |  |
|  | R <sub>0JL</sub> <sup>(1)</sup> | 30    |       |       |       | 0/10 |  |  |

## Note

(1) Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |  |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |  |  |
| EGF1DHE3_B/H <sup>(1)</sup>    | 0.104           | Н                      | 1500          | 7" diameter plastic tape and reel  |  |  |  |
| EGF1DHE3_B/I (1)               | 0.104           | I                      | 6500          | 13" diameter plastic tape and reel |  |  |  |

### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

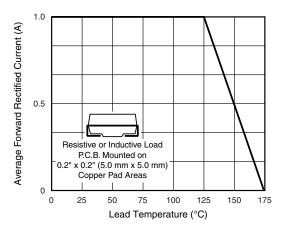


Fig. 1 - Maximum Forward Current Derating Curve

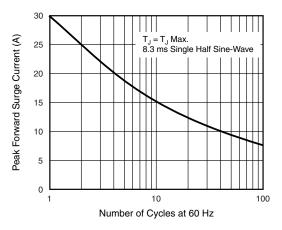


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

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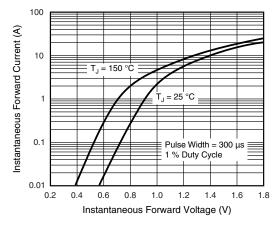


Fig. 3 - Typical Instantaneous Forward Characteristics

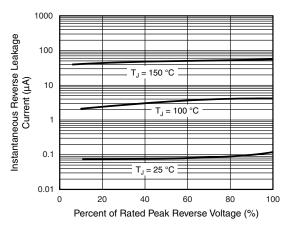


Fig. 4 - Typical Reverse Leakage Characteristics

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

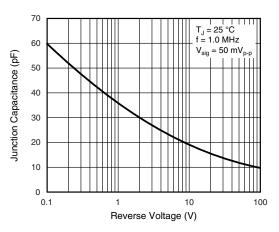


Fig. 5 - Typical Junction Capacitance

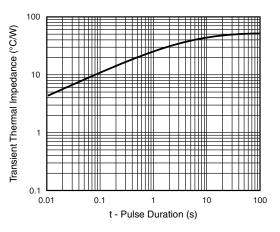
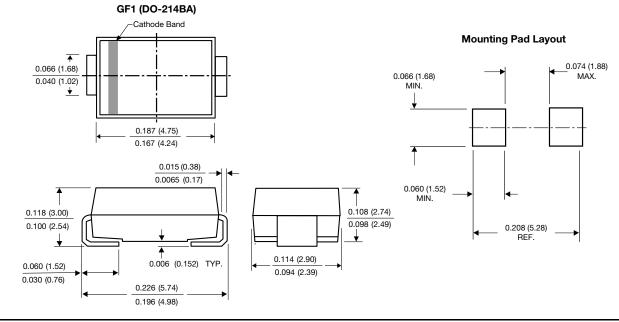


Fig. 6 - Typical Transient Thermal Impedance



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